

Revision History AS7C31026B

Revision	Details	Date
Rev 1.0	Initial Issue	March 2004
Rev 1.1	10ns TSOP II not offered due to poor yields	April 2007
Rev 2.0	industrial temp TSOP II not offered due to poor yields - refer to 'C' die option for TSOP II. We can still offer in SOJ industrial temp.	August 2009
Rev 3.0	Re-introduced 12ns, 15ns and 20ns Industrial Graded parts (AS7C31026B-12TIN, AS7C31026B-15TIN & AS7C31026B-20TIN) in TSOP II package.	March 2022

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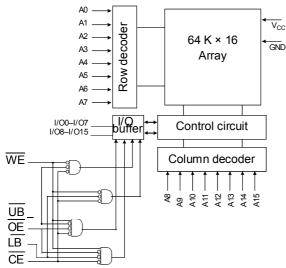
3.3V 1Mb (64K x 16) FAST Asynchronous SRAM

Features

- · Industrial and Commercial versions
- Organization: 65,536 words × 16 bits
- Center power and ground pins for low noise
- High speed
- 10/12/15/20 ns address access time
- 5, 6, 7, 8 ns output enable access time
- Low power consumption: ACTIVE - 288 mW / max @ 10 ns
- Low power consumption: STANDBY
 - 18 mW / max CMOS I/O

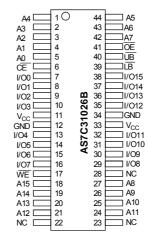
- Easy memory expansion with \overline{CE} , \overline{OE} inputs
- TTL-compatible, three-state I/O
- JEDEC standard packaging
 - 44-pin 400 mil SOJ
 - 44-pin TSOP 2
- ESD protection ≥ 2000 volts
- Latch-up current $\geq 200 \text{ mA}$

Logic block diagram



Pin arrangement

44-Pin SOJ (400 mil), TSOP 2



Selection guide

	-10	-12	-15	-20	Unit
Maximum address access time	10	12	15	20	ns
Maximum output enable access time	5	6	7	8	ns
Maximum operating current	80	75	70	65	mA
Maximum CMOS standby current	5	5	5	5	mA



Functional description

The AS7C31026B is a high-performance CMOS 1,048,576-bit Static Random Access Memory (SRAM) device organized as 65,536 words \times 16 bits. It is designed for memory applications where fast data access, low power, and simple interfacing are desired.

Equal address access and cycle times (t_{AA} , t_{RC} , t_{WC}) of 10/12/15/20 ns with output enable access times (t_{OE}) of 5, 6, 7, 8 ns are ideal for high-performance applications.

When \overline{CE} is high, the device enters standby mode. A write cycle is accomplished by asserting write enable (\overline{WE}) and chip enable (\overline{CE}). Data on the input pins I/O0 through I/O15 is written on the rising edge of \overline{WE} (write cycle 1) or \overline{CE} (write cycle 2). To avoid bus contention, external devices should drive I/O pins only after outputs have been disabled with output enable (\overline{OE}) or write enable (\overline{WE}).

A read cycle is accomplished by asserting output enable (\overline{OE}) and chip enable (\overline{CE}) with write enable (\overline{WE}) high. The chips drive I/O pins with the data word referenced by the input address. When either chip enable or output enable is inactive or write enable is active, output drivers stay in high-impedance mode.

The device provides multiple center power and ground pins, and separate byte enable controls, allowing individual bytes to be written and read. \overline{LB} controls the lower bits, I/O0 through I/O7, and \overline{UB} controls the higher bits, I/O8 through I/O15.

All chip inputs and outputs are TTL-compatible, and operation is from a single 3.3 V supply. The device is packaged in common industry standard packages.

Absolute maximum ratings

Parameter	Symbol	Min	Max	Unit
Voltage on V _{CC} relative to GND	V _{t1}	-0.50	+5.0	V
Voltage on any pin relative to GND	V _{t2}	-0.50	V _{CC} +0.50	V
Power dissipation	P _D	-	1.0	W
Storage temperature (plastic)	T _{stg}	-65	+150	°C
Ambient temperature with VCC applied	T _{bias}	-55	+125	°C
DC current into outputs (low)	I _{OUT}	-	20	mA

Note: Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Truth table

CE	WE	OE	LB	UB	I/O0–I/O7	I/O8–I/O15	Mode
Н	Х	Х	Х	Х	High Z	High Z	Standby (I _{SB}), I _{SBI})
L	Н	L	L	Н	D _{OUT}	High Z	Read I/O0–I/O7 (I _{CC})
L	Н	L	Н	L	High Z	D _{OUT}	Read I/O8–I/O15 (I _{CC)}
L	Н	L	L	L	D _{OUT}	D _{OUT}	Read I/O0–I/O15 (I _{CC})
L	L	Х	L	L	D _{IN}	D _{IN}	Write I/O0–I/O15 (I _{CC})
L	L	Х	L	Н	D _{IN}	High Z	Write I/O0–I/O7 (I _{CC})
L	L	Х	Н	L	High Z	D _{IN}	Write I/O8–I/O15 (I _{CC})
L	Н	Н	Х	Х	High Z	High Z	Output disable (I _{CC})
L	Х	Х	Н	Н	842	8-12	

Key: H = high, L = low, X = don't care.



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Recommended operating conditions

Parameter	Symbol	Min	Nominal	Max	Unit	
Supply voltage	V _{CC}	3.0	3.3	3.6	V	
Input voltage	V _{IH}	2.0	_	$V_{CC} + 0.5$	V	
				_	0.8	V
Ambient operating temperature	commercial	T _A	0	_	70	° C
Amblent operating temperature	industrial	T _A	-40	_	85	° C

 V_{IL} = -1.0V for pulse width less than 5ns $V_{IH} = V_{CC} + 1.5V$ for pulse width less than 5ns

DC operating characteristics (over the operating range) I

			-1	10	-]	-12		-15		-20	
Parameter	Sym	Test conditions	Min	Max	Min	Max	Min	Max	Min	Max	Unit
Input leakage current	I _{LI}	$V_{CC} = Max$ $V_{IN} = GND$ to V_{CC}	_	1	_	1	_	1	_	1	μА
Output leakage current	I _{LO}	$\frac{V_{CC} = Max}{CE} = V_{IH},$ $V_{OUT} = GND \text{ to } V_{CC}$	-	1	_	1	_	1	_	1	μΑ
Operating power supply current	I _{CC}	$\label{eq:VCC} \begin{split} & V_{CC} = Max, \\ \hline CE \leq V_{IL}, \ I_{OUT} = 0mA \\ & f = f_{Max} \end{split}$	-	80	_	75	_	70	_	65	mA
Standby	I _{SB}	$\frac{V_{CC} = Max,}{CE \ge V_{IH}, f = f_{Max}}$	_	30	_	25	_	20	_	20	mA
power supply current	I _{SB1}	$V_{CC} = Max, \overline{CE} \ge V_{CC} - 0.2 V,$ $V_{IN} \le 0.2 V \text{ or}$ $V_{IN} \ge V_{CC} - 0.2 V, f = 0$	_	5	_	5	_	5	_	5	mA
Output	V _{OL}	I_{OL} = 8 mA, V_{CC} = Min	-	0.4	-	0.4	-	0.4	_	0.4	V
voltage	V _{OH}	$I_{OH} = -4 \text{ mA}, V_{CC} = \text{Min}$	2.4	-	2.4	-	2.4	-	2.4	-	V

Capacitance (f = 1MHz, $T_a = 25 \text{ °C}, V_{CC} = \text{NOMINAL})^2$

Parameter	Symbol	Signals	Test conditions	Max	Unit
Input capacitance	C _{IN}	A, \overline{CE} , \overline{WE} , \overline{OE} , \overline{LB} , \overline{UB}	$V_{IN} = 0 V$	5	pF
I/O capacitance	C _{I/O}	I/O	$V_{IN} = V_{OUT} = 0 V$	7	pF



Read cycle (over the operating range)^{3,9}

		-1	0	-1	2	-1	5	-2	0		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Read cycle time	t _{RC}	10	-	12	-	15	-	20	-	ns	
Address access time	t _{AA}	I	10	-	12	_	15	_	20	ns	3
Chip enable (\overline{CE}) access time	t _{ACE}	1	10	-	12	-	15	_	20	ns	3
Output enable (OE) access time	t _{OE}	-	5	-	6	-	7	-	8	ns	
Output hold from address change	t _{OH}	3	-	3	-	3	-	3	-	ns	5
CE low to output in low Z	t _{CLZ}	3	-	3	-	3	-	3	-	ns	4, 5
CE high to output in high Z	t _{CHZ}	-	3	-	3	-	4	-	5	ns	4, 5
OE low to output in low Z	t _{OLZ}	0	-	0	-	0	-	0	-	ns	4, 5
Byte select access time	t _{BA}	-	5	-	6	-	7	-	8	ns	
Byte select Low to low Z	t _{BLZ}	0	-	0	-	0	-	0	-	ns	4, 5
Byte select High to high Z	t _{BHZ}	-	5	-	6	-	6	-	8	ns	4, 5
OE high to output in high Z	t _{OHZ}	-	5	-	6	-	7	-	8	ns	4, 5
Power up time	t _{PU}	0	-	0	_	0	-	0	_	ns	4, 5
Power down time	t _{PD}	-	10	_	12	_	15		20	ns	4, 5

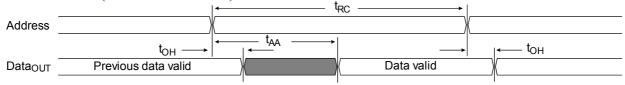
Key to switching waveforms

Rising input

Selling input

Undefined output/don't care

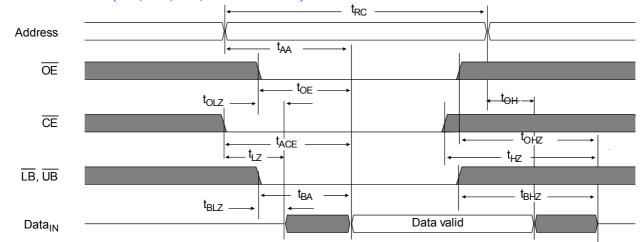
Read waveform 1 (address controlled)^{3,6,7,9}





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Read waveform 2 (OE, CE, UB, LB controlled)^{3,6,8,9}



Write cycle (over the operating range)¹¹

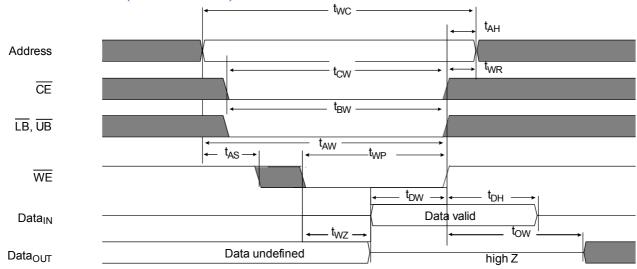
		-]	10	-1	2	-]	15	-2	20		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Write cycle time	t _{WC}	10	-	12	-	15	-	20	-	ns	
Chip enable (\overline{CE}) to write end	t _{CW}	8	-	9	_	10	_	12	_	ns	
Address setup to write end	t _{AW}	8	-	9	_	10	_	12	_	ns	
Address setup time	t _{AS}	0	-	0	_	0	-	0	_	ns	
Write pulse width	t _{WP}	7	-	8	_	9	-	12	-	ns	
Write recovery time	t _{WR}	0	-	0	-	0	-	0	-	ns	
Address hold from end of write	t _{AH}	0	-	0	_	0	-	0	-	ns	
Data valid to write end	t _{DW}	5	-	6	_	8	_	10	_	ns	
Data hold time	t _{DH}	0	-	0	_	0	_	0	_	ns	5
Write enable to output in high Z	t _{WZ}	_	5	-	6	-	7	-	8	ns	4, 5
Output active from write end	t _{OW}	1	-	1	-	1	-	2	-	ns	4, 5
Byte select low to end of write	t _{BW}	7	-	8	-	9	-	9	-	ns	



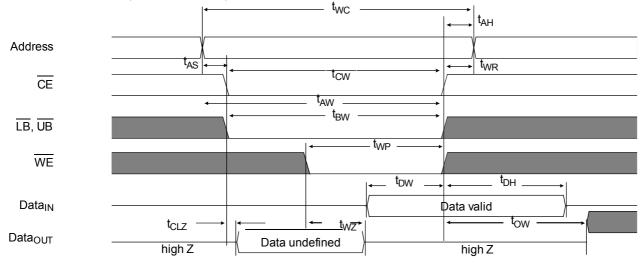
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3.3V 1Mb (64K x 16) FAST Asynchronous SRAM

Write waveform 1 (WE controlled)^{10,11}



Write waveform 2 (CE controlled)^{10,11}

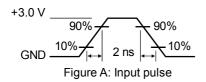


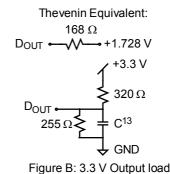


3.3V 1Mb (64K x 16) FAST Asynchronous SRAM

AC test conditions

- Output load: see Figure B.
- Input pulse level: GND to 3.0 V. See Figure A.
- Input rise and fall times: 2 ns. See Figure A.
- Input and output timing reference levels: 1.5





Notes

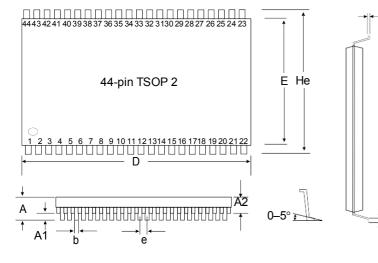
- 1 During V_{CC} power-up, a pull-up resistor to V_{CC} on \overline{CE} is required to meet I_{SB} specification.
- 2 This parameter is sampled, but not 100% tested.
- 3 For test conditions, see AC Test Conditions, Figures A and B.
- 4 These parameters are specified with $C_L = 5 \text{ pF}$, as in Figures B. Transition is measured $\pm 500 \text{ mV}$ from steady-state voltage.
- 5 This parameter is guaranteed, but not tested.
- $\overline{\text{WE}}$ is high for read cycle.
- 7 $\overline{\text{CE}}$ and $\overline{\text{OE}}$ are low for read cycle.
- 8 Address is valid prior to or coincident with $\overline{\text{CE}}$ transition low.
- 9 All read cycle timings are referenced from the last valid address to the first transitioning address.
- 10 Not applicable.
- 11 All write cycle timings are referenced from the last valid address to the first transitioning address.
- 12 Not applicable.
- 13 C = 30 pF, except all high Z and low Z parameters where C = 5 pF.



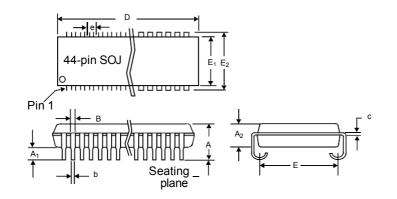
3.3V 1Mb (64K x 16) FAST Asynchronous SRAM

С

Package dimensions



	44-pin]	rsop 2				
	Min (mm)	Max (mm)				
A		1.2				
A1	0.05	0.15				
A2	0.95	1.05				
b	0.30	0.45				
c	0.120	0.21				
D	18.31	18.52				
E	10.06	10.26				
He	11.68	11.94				
e	0.80 (typical)					
1	0.40	0.60				



	44-pin SOJ 400 mil							
	Min (in)	Max (in)						
Α	0.128	0.148						
A ₁	0.025	_						
A ₂	0.105	0.115						
B	0.026	0.032						
b	0.015	0.020						
с	0.007	0.013						
D	1.120	1.130						
E	0.370	NOM						
E ₁	0.395	0.405						
E ₂	0.435	0.445						
е	0.050	NOM						



3.3V 1Mb (64K x 16) FAST Asynchronous SRAM

Ordering codes					
Package	Volt/Temp	10 ns	12 ns	15 ns	20 ns
Plastic SOJ, 400 mil	3.3V Commercial	AS7C31026B-10JCN	AS7C31026B-12JCN	AS7C31026B-15JCN	AS7C31026B-20JCN
1 lastic 505, 400 lilli	3.3V Industrial	AS7C31026B-10JIN	AS7C31026B-12JIN	AS7C31026B-15JIN	AS7C31026B-20JIN
TSOP2, 10.2 x 18.4 mm	3.3V Commercial	AS7C31026B-10TCN	AS7C31026B-12TCN	AS7C31026B-15TCN	AS7C31026B-20TCN
10012, 10.2 x 10. Thin	3.3V Industrial	-	AS7C31026B-12TIN	AS7C31026B-15TIN	AS7C31026B-20TIN

Part numbering system

AS7C	Χ	1026B	-XX	X	Χ	Χ	XX
SRAM prefix	Voltage: 3 = 3.3V	Device number 1026: 1Mb (x16) B : revision B	Access time -10 = 10ns -12 = 12ns -15 = 15ns -20 = 20ns	Package: J = SOJ 400 mils T = TSOP2	Temperature range: C = Commercial I = Industrial	N=Lead Free and Halogen Free Part	Packing Type None: Tray TR: Reel





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